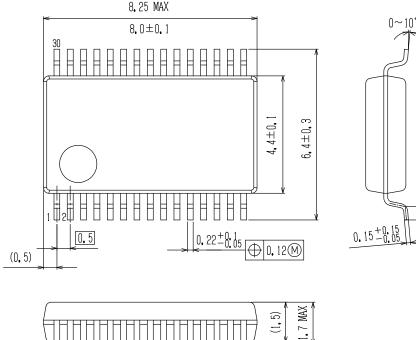


SSOP30 (225 mil) CASE 565AZ **ISSUE A**

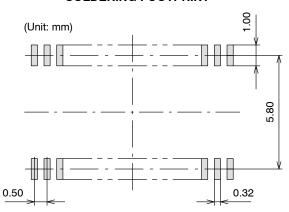
DATE 25 OCT 2013



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0, 1±0,

SOLDERING FOOTPRINT*

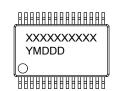


NOTE: The measurements are not to guarantee but for reference only.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*

5±0,8 ð



XXXXX = Specific Device Code

Y = Year

M = Month

DDD = Additional Traceability Data

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

DESCRIPTION:	SSOP30 (225 MIL)		PAGE 1 OF 2
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PAGE 2 OF 2

ISSUE	REVISION	DATE	
0	RELEASED FOR PRODUCTION FROM SANYO ENACT # S-526 TO ON SEMICONDUCTOR. REQ. BY D. TRUHITTE.	31 MAY 2012	
Α	ADDED MARKING AND SOLDER FOOTPRINT INFORMATION. REQ. BY D. TRUHITTE	25 OCT 2013	

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